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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Jack O. Chu et al.

Docket No.: YOR920000344US1

Serial No.: 09/692,606

Group Art Unit: 1765

Filed: October 19, 2000

Examiner:

For: LAYER TRANSFER OF LOW DEFECT
SiGe USING AN ETCH-BACK PROCESS

Assistant Commissioner for Patents
Washington, D.C. 20231

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